

BiCD Integrated Circuit Silicon Monolithic

TB62214AFTG

BiCD Constant-Current Two-Phase Bipolar Stepping Motor Driver IC

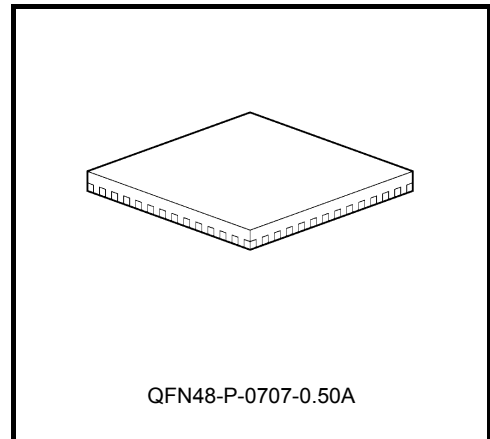
The TB62214AFTG is a two-phase bipolar stepping motor driver using a PWM chopper controlled by clock input.

Fabricated with the BiCD process, the TB62214AFTG is rated at 40 V/2.0 A .

The on-chip voltage regulator allows control of a stepping motor with a single VM power supply.

Features

- Bipolar stepping motor driver
- PWM constant-current drive
- Clock input control
- Allows two-phase, 1-2-phase and W1-2-phase excitations.
- BiCD process: Uses DMOS FETs as output power transistors.
- High voltage and current: 40 V/2.0 A (absolute maximum ratings)
- Thermal shutdown (TSD), overcurrent shutdown (ISD), and power-on-resets (PORs)
- Packages: QFN48-P-0707-0.50A

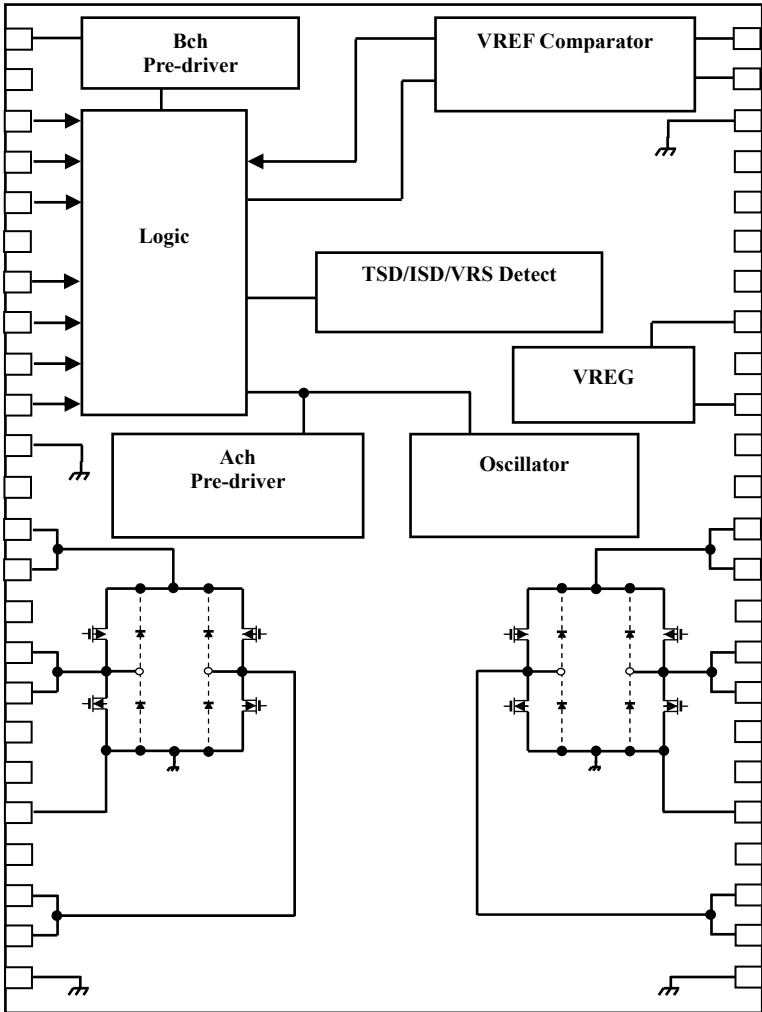


Weight : 0.14 g (typ.)

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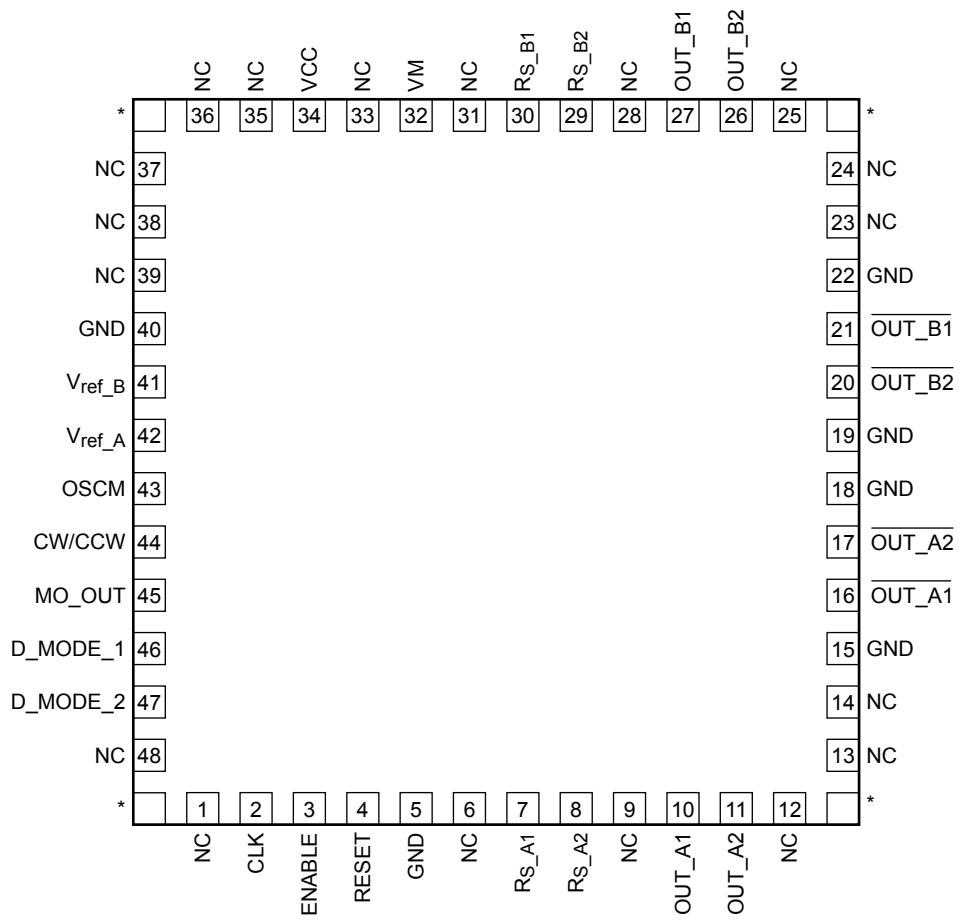
Block Diagram



Functional blocks/circuits/constants in the block chart etc. may be omitted or simplified for explanatory purposes.

Pin Assignment

TB62214AFTG



Pin Function

Pin No.	Pin Name	Function	Pin No.	Pin Name	Function
1	NC	No-connect	25	NC	No-connect
2	CLK	An electrical angle leads on the rising edge of the clock input. A motor rotation count depends on the input frequency.	26	OUT_B2	B-phase positive driver output
3	ENABLE	A-/B-channel output enable	27	OUT_B1	
4	RESET	Electric angle reset	28	NC	No-connect
5	GND	Logic ground	29	RS_B2	Power supply of B-phase motor coil and the sink current sensing of B-phase motor coil
6	NC	No-connect	30	RS_B1	
7	RS_A1	Power supply of A-phase motor coil and the sink current sensing of A-phase motor coil	31	NC	No-connect
8	RS_A2		32	VM	Power supply
9	NC	No-connect	33	NC	No-connect
10	OUT_A1	A-phase positive driver output	34	VCC	Smoothing filter for logic power supply
11	OUT_A2		35	NC	No-connect
12	NC	No-connect	36	NC	No-connect
13	NC	No-connect	37	NC	No-connect
14	NC	No-connect	38	NC	No-connect
15	GND	Motor power ground	39	NC	No-connect
16	OUT_A1	A-phase negative driver output	40	GND	Logic ground
17	OUT_A2		41	V _{ref_B}	Tunes the current level for B-phase motor drive.
18	GND	Motor power ground	42	V _{ref_A}	Tunes the current level for A-phase motor drive.
19	GND	Motor power ground	43	OSCM	Oscillator pin for PWM chopper
20	OUT_B2	B-phase negative driver output	44	CW/CCW	Motor rotation: forward/reverse
21	OUT_B1		45	MO_OUT	Electric angle monitor
22	GND	Motor power ground	46	D_MODE_1	Excitation mode control
23	NC	No-connect	47	D_MODE_2	Excitation mode control
24	NC	No-connect	48	NC	No-connect

CLK Function

CLK Input	Function
Rise	The electrical angle leads by one on the rising edge.
Fall	Remains at the same position.

ENABLE Function

ENABLE Input	Function
H	Output transistors are enabled (normal operation mode).
L	Output transistors are disabled (high impedance state).

CW/CCW Function

CW/CCW Input	Function
H	Forward (CW)
L	Reverse (CCW)

Excitation Mode Select Function

D_MODE_1	D_MODE_2	Function
L	L	OSC_M, output transistors are disabled (in Standby mode)
L	H	Two-phase excitation
H	L	1-2-phase excitation
H	H	W1-2-phase excitation

RESET Function

RESET Input	Function
L	Normal operation mode
H	The electrical angle is reset.

Excitation Mode	A-phase Current	B-phase Current
2 Phase	100%	100%
1 – 2 Phase	100%	100%
W1-2 Phase	71%	71%

Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Motor power supply	VM	40	V
Motor output voltage	V _{OUT}	40	V
Motor output current	I _{OUT}	2.0	A
Digital input voltage	V _{IN}	-0.5 to 6.0	V
Vref standard voltage	V _{ref}	5.0	V
MO output voltage	VM _O	6.0	V
MO output sink current	I _{MO}	30.0	mA
Power dissipation	P _D	1.15	W
Operating temperature	T _{opr}	-20 to 85	°C
Storage temperature	T _{stg}	-55 to 150	°C
Junction temperature	T _j (MAX)	150	°C

Operating Ranges (Ta=0 to 85°C)

Characteristics	Symbol	Min	Typ.	Max	Unit
Motor power supply	VM	10.0	24.0	38.0	V
Motor output current	I _{OUT}	-	1.4	2.0	A
Digital input voltage	V _{IN} (H)	2.0	-	5.5	V
	V _{IN} (L)	-0.4	-	1.0	V
MO output voltage	VM _O	-	3.3	5.5	V
Clock input frequency	f _{CLK}	-	-	100	kHz
Chopper frequency	f _{chop}	40.0	100.0	150	kHz
V _{ref} reference voltage	V _{ref}	GND	-	3.6	V
Voltage across the current-sensing resistor pins	V _{RS}	0.0	±1.0	±1.5	V

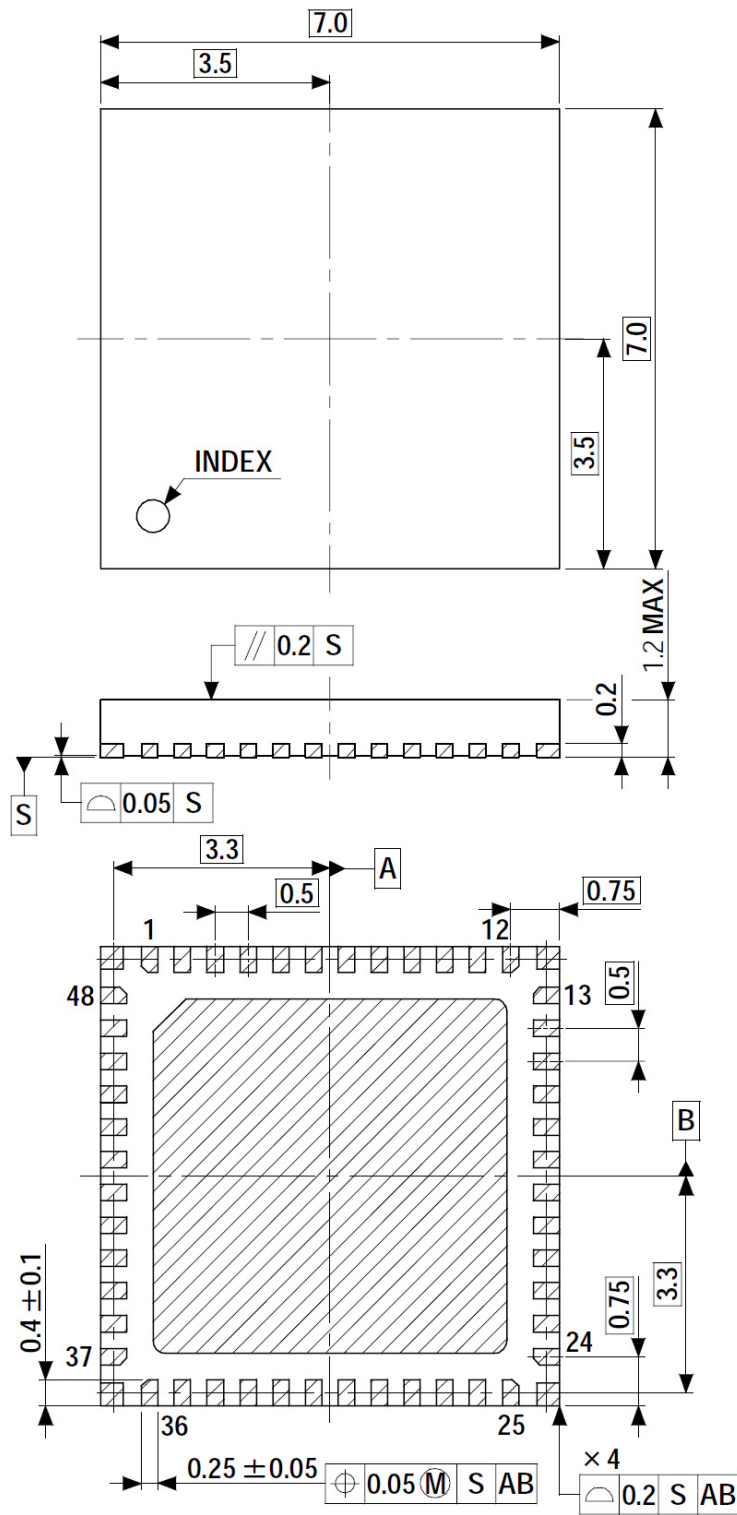
Electrical Characteristics (Ta = 25°C, VM = 24 V, unless otherwise specified)

Characteristics		Symbol	Test Circuit	Test Condition	Min	Typ.	Max	Unit
Input hysteresis voltage		V _{IN (HIS)}	DC	Digital input pins	100	200	300	mV
Digital input current	High	I _{IN (H)}	DC	V _{IN} = 5 V at the digital input pins under test	35	50	75	μA
	Low	I _{IN (L)}	DC	V _{IN} = 0 V at the digital input pins under test	–	–	1	μA
MO output voltage	High	V _{OH (MO)}	–	I _{OH} = -24 mA when the output is High	2.4	–	–	V
	Low	V _{OL (MO)}	–	I _{OL} = 24 mA when the output is Low	–	–	0.5	V
Supply current		I _{M1}	DC	Outputs open, In standby mode	–	2	3	mA
		I _{M2}	DC	Outputs open, ENABLE = Low	–	3.5	5	mA
		I _{M3}	DC	Outputs open (two-phase excitation)	–	5	7	mA
Output leakage current	High-side	I _{OH}	DC	V _{RS} = VM = 40 V, V _{OUT} = 0 V	–	–	1	μA
	Low-side	I _{OL}	DC	V _{RS} = VM = V _{OUT} = 40 V	1	–	–	μA
Channel-to-channel differential		ΔI _{OUT1}	DC	Channel-to-channel error	–5	0	5	%
Output current error relative to the predetermined value		ΔI _{OUT2}	DC	I _{OUT} = 1 A	–5	0	5	%
R _S pin current		I _{RS}	DC	V _{RS} = VM = 24 V	0	–	10	μA
Drain-source ON-resistance of the output transistors (upper and lower sum)		R _{ON (D-S)}	DC	I _{OUT} = 2.0 A, T _J = 25°C	–	1.0	1.5	Ω

Package Dimensions

QFN48-P-0707-0.50A

“Unit : mm”



Notes on Contents

Block Diagrams

Some of the functional blocks, circuits, or constants in the block diagram may be omitted or simplified for explanatory purposes.

IC Usage Considerations

Notes on handling of ICs

- (1) The absolute maximum ratings of a semiconductor device are a set of ratings that must not be exceeded, even for a moment. Do not exceed any of these ratings.
Exceeding the rating(s) may cause the device breakdown, damage or deterioration, and may result in injury by explosion or combustion.
- (2) Use an appropriate power supply fuse to ensure that a large current does not continuously flow in case of over current and/or IC failure. The IC will fully break down when used under conditions that exceed its absolute maximum ratings, when the wiring is routed improperly or when an abnormal pulse noise occurs from the wiring or load, causing a large current to continuously flow and the breakdown can lead smoke or ignition. To minimize the effects of the flow of a large current in case of breakdown, appropriate settings, such as fuse capacity, fusing time and insertion circuit location, are required.
- (3) If your design includes an inductive load such as a motor coil, incorporate a protection circuit into the design to prevent device malfunction or breakdown caused by the current resulting from the inrush current at power ON or the negative current resulting from the back electromotive force at power OFF. IC breakdown may cause injury, smoke or ignition.
Use a stable power supply with ICs with built-in protection functions. If the power supply is unstable, the protection function may not operate, causing IC breakdown. IC breakdown may cause injury, smoke or ignition.
- (4) Do not insert devices incorrectly or in the wrong orientation.
Make sure that the positive and negative terminals of power supplies are connected properly. Otherwise, the current or power consumption may exceed the absolute maximum rating, and exceeding the rating(s) may cause breakdown, damage or deterioration of the device, and may result in injury by explosion or combustion.
In addition, do not use any device that has had current applied to it while inserted incorrectly or in the wrong orientation even once.
- (5) Carefully select power amp, regulator, or other external components (such as inputs and negative feedback capacitors) and load components (such as speakers).
If there is a large amount of leakage current such as input or negative feedback capacitors, the IC output DC voltage will increase. If this output voltage is connected to a speaker with low input withstand voltage, overcurrent or IC failure can cause smoke or ignition. (The over current can cause smoke or ignition from the IC itself.) In particular, please pay attention when using a Bridge Tied Load (BTL) connection type IC that inputs output DC voltage to a speaker directly.

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